

### ■ PRODUCT CHARACTERISTICS

V <sub>DSS</sub>	60V
R <sub>DSON</sub> Typ(@V <sub>GS</sub> =10V)	4.6mΩ
I <sub>D</sub>	120A

### ■ FEATURES

Load Switch

PWM Application

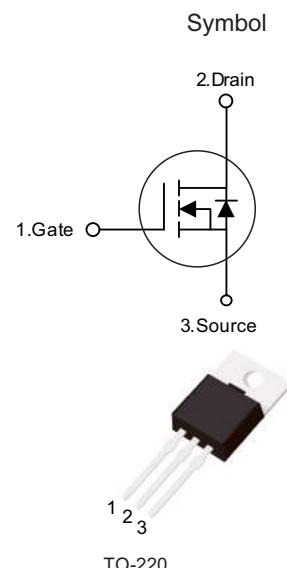
Power management

### ■ APPLICATION

Advanced Trench Technology

Provide Excellent R<sub>DSON</sub> and Low Gate Charge

Lead free product is acquired



### ■ ORDER INFORMATION

Order codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT120N06A	TO-220	50 pieces/Tube

### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V <sub>DS</sub>	60	V
Gate-to-Source Voltage	V <sub>GS</sub>	±25	V
Continuous Drain Current	I <sub>D</sub>	120	A
T <sub>C</sub> = 25°C			
T <sub>C</sub> = 100°C	I <sub>D</sub>	78	A
Pulsed Drain Current	I <sub>DM</sub>	480	A
Avalanche Energy	E <sub>AS</sub>	400	mJ
Power Dissipation	P <sub>D</sub>	181	W
Junction & Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 175	°C
Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	0.83	°C/W

**■ ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C, unless otherwise noted)**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>Static parameter</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	60	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V T <sub>J</sub> = 55°C	-	-	1.0	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±25V	-	-	±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2.0	-	4	V
Static Drain-Source ON-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 30A	-	4.6	6	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 20A	10	-	-	S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1A, V <sub>GS</sub> = 0V	-	-	1	V
Diode Continuous Current	I <sub>S</sub>	T <sub>C</sub> = 25°C	-	-	120	A
<b>Dynamic parameter</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz	-	5672	-	pF
Output Capacitance	C <sub>oss</sub>		-	392	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	352	-	pF
<b>Switching parameter</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> = 10V V <sub>DS</sub> = 30V, I <sub>D</sub> = 30A	-	103	-	nC
Gate Source Charge	Q <sub>gs</sub>		-	15	-	nC
Gate Drain Charge	Q <sub>gd</sub>		-	32	-	nC
Turn-On Delay Time	t <sub>D(on)</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 30V I <sub>D</sub> = 30A, R <sub>O</sub> = 1.8Ω	-	12	-	nS
Turn-On Rise Time	t <sub>r</sub>		-	8	-	nS
Turn-Off Delay Time	t <sub>D(off)</sub>		-	49	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	15	-	nS
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 30A, dI <sub>F</sub> /dt = 100A/μs	-	27	-	nS
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 30A, dI <sub>F</sub> /dt = 100A/μs	-	48	-	nC

■ TYPICAL CHARACTERISTICS

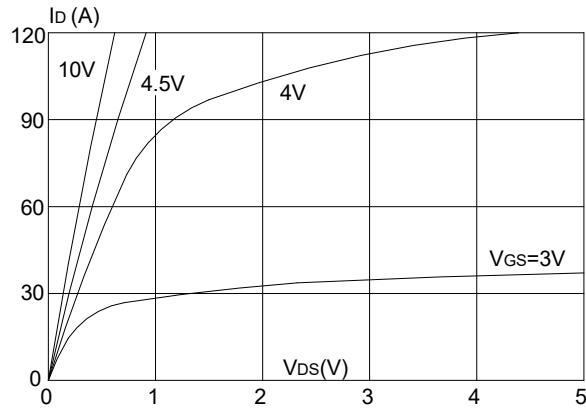


Figure 1 output characteristics

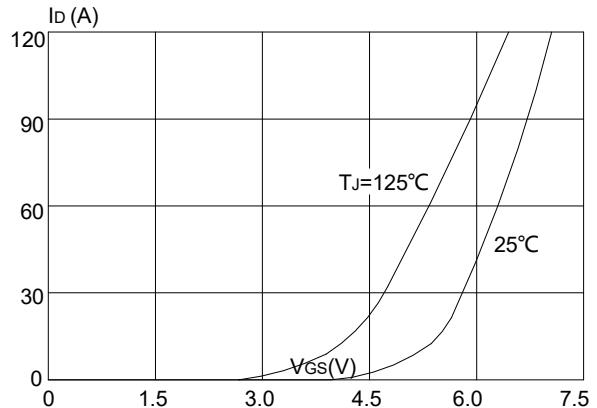


Figure 2 typical transfer characteristics

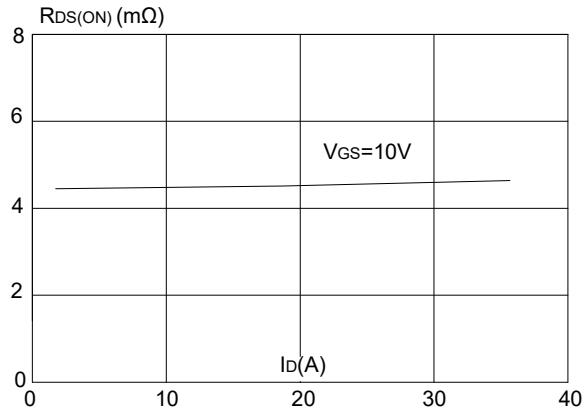


Figure 3 on-resistance vs. drain current

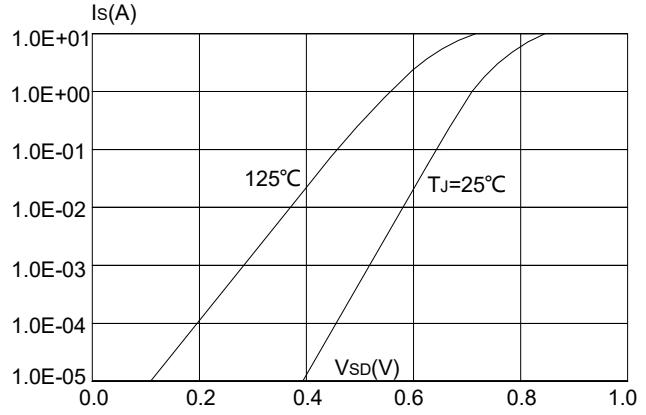


Figure 4 body diode characteristics

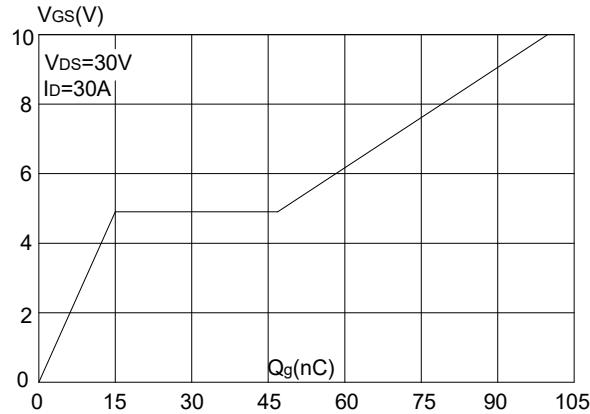


Figure 5 gate charge characteristics

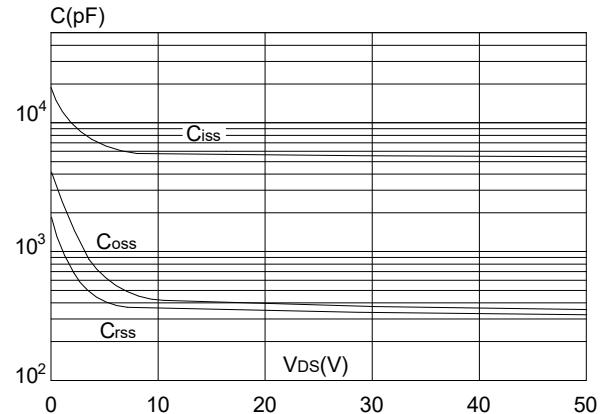


Figure 6 capacitance characteristics

## ■ TYPICAL CHARACTERISTICS(Cont.)

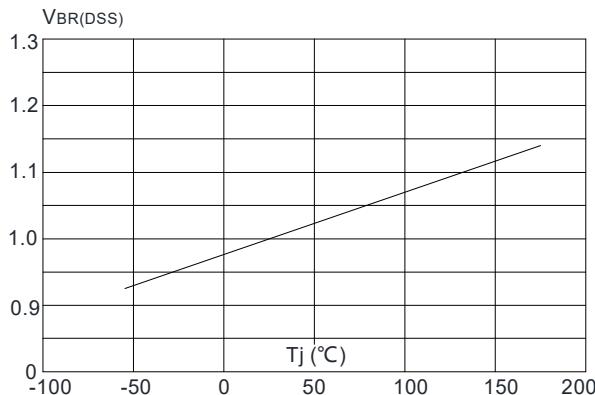


Figure 7 normalized breakdown voltage vs. junction temperature

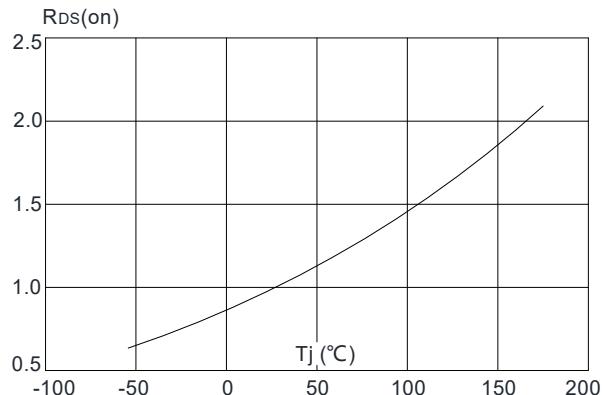


Figure 8 normalized on resistance vs. junction temperature

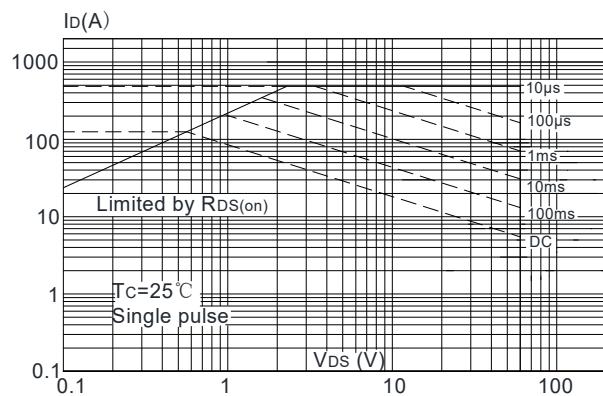


Figure 9 maximum safe operating area

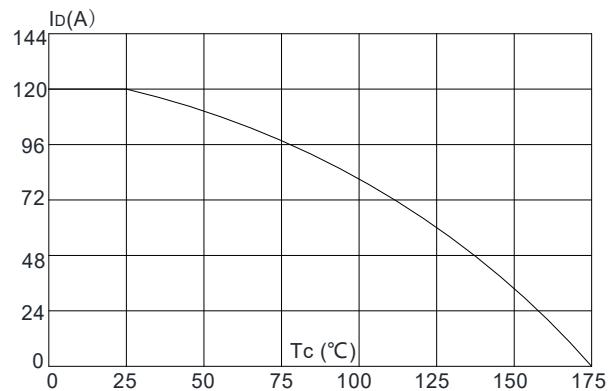


Figure 10 maximum continuous drain current vs. case temperature

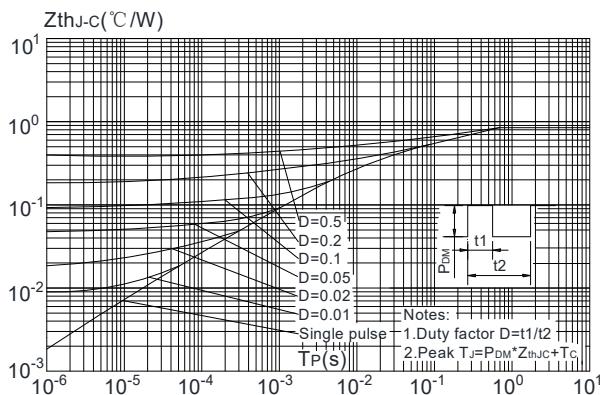


Figure 11 maximum effective transient impedance, junction to case

■ TO-220-3L PACKAGE OUTLINE DIMENSIONS

